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Approved by:

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SPECIFICATION

PRODUCT: SAW FILTER

MODEL: HDVF389A4M



SHOULDER ELECTRONICS LIMITED

1.SCOPE

SHOULDER'S SAW filter series have broad line up products meeting all broadcast standard including NTSC,PAL and SECAM systems. These filters are composed of two interdigital transducers on a single-crystal. piezoelectrical chip. they are used in electronic equipments such as TV and so on.

2.Construction

2.1 Dimension and materials

Manufacturer's name : SHOULDER ELECTRONICS Co. LTD(CHINA)

Type : VF389A4M



0: year(0,1,2,3,4,5,6,7,8,9)

B:product in this quarter(A:1~3,B:4~6,C:7~9,D:10~12)



Components	Materials	
1.Outer casing	PPS	
2.Substrate	Lithium niobate	
3.Base	Epoxy resin	
4.Absorber	Epoxy resin	
5.Lead	Cu alloy+Au plate	
6.Bonding wire	AlSi alloy	
7.Electrode	AI	
7.Electrode	AI	

2.2. Circuit construction, measurement circuit



Test circuit for SIP-5 filter Input impedance of the symmetrical post-amplifier: 2 k Ω in parallel with 3 pF

3.Characteristics

Items	Conditions	Specifications
Standard atmospheric conditions	Unless otherwise specified, the standard rang of atmospheric conditions for making measurements and tests is as follows; Ambient temperature : 15°C to 35°C Relative humidity : 25% to 85% Air pressure : 86kPa to 106kPa	
Operating	Operating temperature rang is the rang of ambient	
temperature rang	temperatures in which the filter can be	There shall be no
	operated continuously. -10° C ~ $+60^{\circ}$ C	damage.
Storage	Storage temperature rang is the rang of ambient	
temperature rang	temperatures at which the filter can be stored	
	without damage.	
	Conditions are as specified elsewhere in these specifications. -40° C ~ $+70^{\circ}$ C	
Reference	+25°C	
temperature		

3.1 Maximum Rating

DC voltage VDC	12	V	Between any terminals
AC voltage Vpp	10	V	Between any terminals

3.2 Electrical Characteristics

Characteristics of channel

Source impedance	$Zs=50\Omega$		
Load impedance	$Z_L=2k\Omega//3pF$	$T_A=25$ °C	

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Item		Freq	min	typ	max	
Insertion att Reference		37.40MHz	11.8	13.8	15.8	dB
		38.90MHz	4.6	6.1	7.6	dB
		34.47MHz	-0.5	1.0	2.5	dB
		33.40MHz	24.0	39.0	-	dB
		33.15MHz	-	25.0	-	dB
		33.90MHz	-	7.0	-	dB
		30.90MHz	42.0	55.0	-	dB
Relative att	enuation	31.90MHz	42.0	55.0	-	dB
		31.40MHz	40.0	52.0	-	dB
		32.40MHz	42.0	50.0	-	dB
		40.15MHz	38.0	50.0	-	dB
		40.40MHz	42.0	50.0	-	dB
		41.40MHz	42.0	47.0	-	dB
		-31.90MHz	35.0	42.0	-	dB
Sidelobe	40.40~45.00MHz		33.0	38.0	-	dB
Temp	Temperature coefficient			-72		ppm/k
						1

3.3 Environmental Performance Characteristics

Item	Conditior	Specifications	
High temperature	The specimen shall be store at 80 ± 2 °C for 96±4h. Then it sha standard atmospheric condition which measurement shall be r		
Low temperature	The specimen shall be store at 20 ± 3 °C for 96±4h. Then it shats standard atmospheric conditions which measurement shall be r	all be subjected to ons for 1h, after	
Humidity	The specimen shall be store at 40±2°C with relative humidity 96±4h. Then it shall be subject atmospheric conditions for 1h measurement shall be made w		
Thermal shock	The specimen shall be subject cycles each as shown below. ' subjected to standard atmosph 1h, after which measurement within 1h.		
	Temperature 1 +25 °C =>-40 °C 2 -40 °C 3 -40 °C =>+85 °C 4 +85 °C 5 +85 °C =>+25 °C 6 +25 °C	Duration 0.5h 4h 2h 4h 0.5h 1h	Mechanical characteristics and specifications in electrical characteristics shall be satisfied. There
Resistance to Soldering heat	Reflow soldering method Peak: 255 ±5 °C, 220 ±5 °C, 4 At electrode temperature of th	40s	shall be no excessive change in appearance.
	Temperature profil 300 250 200 200 Pre-heating 150 50 1 to 2 min. Temperature profil 40 s 10 s		

	The specimen shall be passed through the reflow furnace with the condition shown in the above profile for 1 time.	
	The specimen shall be stored at standard atmospheric conditions for 1h, after which the measurement shall be made. Test board shall be 1.6 mm thick. Base material shall be glass fabric base epoxy resin.	
Solder ability	Immerse the pins melt solder at $260^{\circ}C+5/-0^{\circ}C$ for 5 sec.	More then 95% of total area of the pins should be covered with solder

3.4 Mechanical Test

Items	Conditions	Specifications
Vibration	600-3300rpm amplitude 1.5mm	
	3 directions 2 H each	
Drop	On maple plate from 1 m high 3 times	
		There shall be no
Lead pull	Pull with 1 kg force for 30 seconds	damage.
Lead bend	90° bending with 500g weigh 2 times	

3.5 Voltage Discharge Test

Item	Condition	Specifications
Surge	Between any two electrode	There shall be no damage

3.6 Frequency response



